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PATENT
Attorney Docket No.: 18419D-009011US

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

On January 5, 2005

TOWNSEND and TOWNSEND and CREW LLP

By: Valerie L. Peterson

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Sharon N. Farrens et al.

Application No.: 10/680,874

Filed: October 6, 2003

For: IN SITU PLASMA WAFER
BONDING METHOD

Customer No.: 20350

Confirmation No. 4386

Examiner: Evan T. Pert

Technology Center/Art Unit: 2829

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed August 12, 2004, please enter the following amendments and remarks:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.